2-2347090-1 <

TE Internal #: 2-2347090-1 LGA Sockets, LGA 4677, 4677 Position, Surface Mount Solder Ball Mount, Grid Spacing .81389 x .9398 mm View on TE.com >



Connectors > Socket Connectors > IC Sockets > LGA Sockets



IC Socket Type: LGA 4677

Connector System: Board-to-Component

Number of Positions: **4677**

Contact Mating Area Plating Material Thickness: [30 µin]

PCB Mounting Style: Surface Mount Solder Ball

Features

Product Type Features

Connector System	Board-to-Component
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Positions	4677
Grid Spacing	.81389 x .9398 mm
Body Features	
Frame Style	Square
Contact Features	
Contact Mating Area Plating Material	Gold
Contact Base Material	Copper Alloy
IC Socket Type	LGA 4677
	30 µin
Contact Current Rating (Max)	.5 A
Mechanical Attachment	
PCB Mounting Style	Surface Mount Solder Ball

2-2347090-1

LGA Sockets, LGA 4677, 4677 Position, Surface Mount Solder Ball Mount, Grid Spacing .81389 x .9398 mm



Housing Features	
Housing Material	LCP (Liquid Crystal Polymer)
Housing Color	Black
Usage Conditions	
Operating Temperature Range	-40 – 100 °C
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Tray Color	Black
Packaging Method	Tray
Other	
Socket Connector Comment	Lead-Free Solderball

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C
Product Compliance Disclaimer This information is provided based on reasonable inquiry of our suppliers an based on the information they provided. This information is subject to chance	

based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous

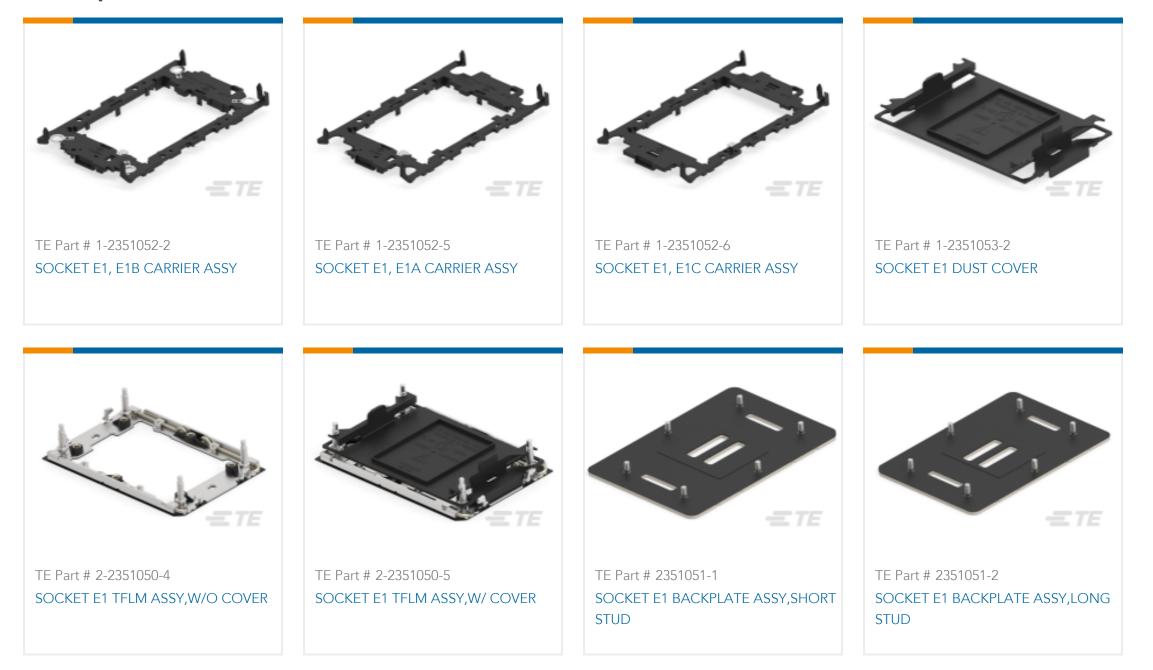
2-2347090-1

LGA Sockets, LGA 4677, 4677 Position, Surface Mount Solder Ball Mount, Grid Spacing .81389 x .9398 mm



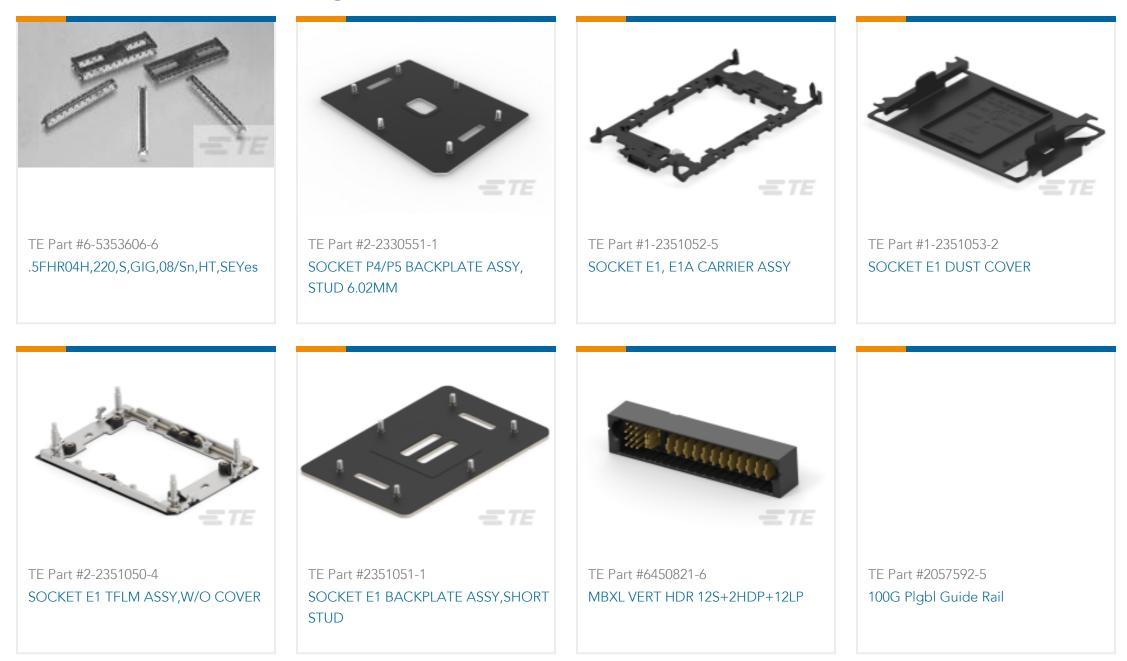
materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Customers Also Bought





2-2347090-1

LGA Sockets, LGA 4677, 4677 Position, Surface Mount Solder Ball Mount, Grid Spacing .81389 x .9398 mm



TE Part #2373624-4 Rcpt Assy,Diecast Housing,PCIe Gen 5 FP+ 1X1 CAGE ASSY, SOLDR TAIL, FLAT BOT

Documents

Product Drawings SOCKET E1 DG1.0 FOR ODM

English

CAD Files

Customer View Model ENG_CVM_CVM_2-2347090-1_7.3d_stp.zip

English

Customer View Model

ENG_CVM_CVM_2-2347090-1_7.3d_igs.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2-2347090-1_7.2d_dxf.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Application Specification

English

Product Environmental Compliance

Product Compliance Document

English

Product Compliance Document

English